

### General Description

The 4N80 uses advanced trench technology and design to provide excellent RDS(ON). This device is ideal for PWM, load switching and general purpose applications.

### Features

- Low On-Resistance
- High Reliability Capability with Passivation
- 100% avalanche tested
- RoHS Compliant

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	800	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	3	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	2.4	A
$I_{DM}$	Pulsed Drain Current	12	A
EAS	Single Pulse Avalanche Energy	200	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	70	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (PCB mount) <sup>2</sup>	---	110	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction -Case	---	1.78	$^\circ C/W$

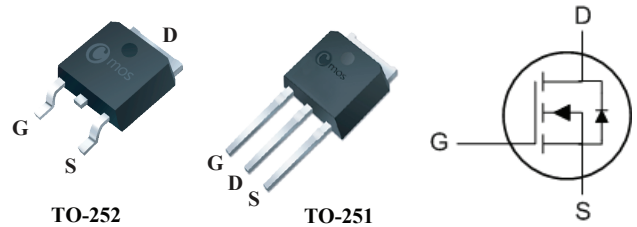
### Product Summary

BVDSS	RDSON	ID
800V	4 $\Omega$	3A

### Applications

- DC-DC Converters
- Power switching application

### TO-252/251 Pin Configuration



Type	Package	Marking
CMD4N80	TO-252	CMD4N80
CMU4N80	TO-251	CMU4N80

**Electrical Characteristics (T<sub>J</sub>=25°C , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =1mA	800	---	---	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =1.5A	---	---	4	Ω
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	2.5	---	4.5	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> = 800V, V <sub>GS</sub> =0V	---	---	1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±30V , V <sub>DS</sub> =0V	---	---	±100	nA
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =1.5A	---	6	---	S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz	---	3.2	---	Ω
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =640V, V <sub>GS</sub> =10V , I <sub>D</sub> =3A	---	20	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	4	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	8	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =400V , I <sub>D</sub> =3A R <sub>G</sub> =25Ω	---	50	---	ns
T <sub>r</sub>	Rise Time		---	35	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	105	---	
T <sub>f</sub>	Fall Time		---	40	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V , V <sub>GS</sub> =0V , f=1MHz	---	920	---	pF
C <sub>oss</sub>	Output Capacitance		---	65	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	10	---	

**Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	---	---	3	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =2.4A , T <sub>J</sub> =25°C	---	---	1.2	V

Note :

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 Cmos assumes no liability for customers' product design or applications.  
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